









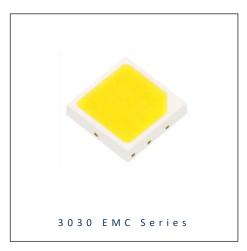




- ► EMC 2-PIN SMD
- ➤ 3030 0.66t
- ► Warm White (2700K)

N0W61S92





3030 EMC Series





FEATURES:

• Package: Top View EMC White Package

Forward Current: 120mA
Forward Voltage (typ.): 6.0V

• Luminous Flux (typ.): 112lm@120mA

• Colour: Warm White

Colour Temperature (CCT): 2700K

• Viewing angle: 120°

Materials:

Die: InGaN

Resin: Silicon (Yellow Diffused)

Package: EMC

Operating Temperature: -40~+105°C
Storage Temperature: -40~+105°C

• Grouping parameters:

Forward Voltage

- Luminous Flux

CIE Chromaticity

Soldering methods: Reflow Soldering

MSL Level: MSL3 according to J-STD020

Packing: 8mm tape with max.5000/reel, ø178mm (7")

APPLICATIONS:

- General Lighting
- Portable Lighting
- Commercial Lighting
- Indoor Lighting
- Backlight for LCD



CHARACTERISTICS:

Absolute Maximum Characteristics (Ta=25°C)

Parameter	Symbol	Ratings	Unit
DC Forward Current	l _F	240	mA
Pulse Forward Current (Duty 1/10, width≤100μS)	IPF	300	mA
Power Dissipation	P _D	1536	mW
Reverse Voltage	V _R	5	V
Reverse Current @10V	I _R	10	μΑ
Junction Temperature	Tj	120	°C
Thermal Resistance (Junction to Solder Point)	R _{THJS}	12	°C/W
Operating Temperature	T _{OPR}	-40~+105	°C
Storage Temperature	T _{STG}	-40~+105	°C
Soldering Temperature	TsoL	230/260 for 10S	°C
Colour Rendering Index	CRI	80	

Electrical & Optical Characteristics (Ta=25°C, RH=60%)

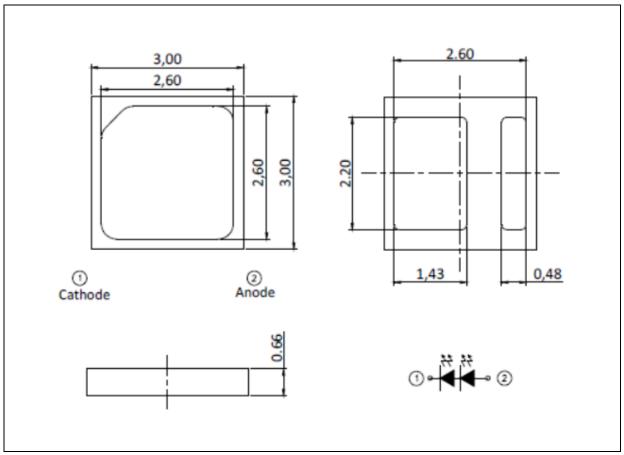
Parameter		Values	Unit	Test		
Parameter	Symbol	Min.	Тур.	Max.	Offic	Condition
Forward Voltage	V_{F}	5.8	6.0	6.6	V	I _F =120mA
Luminous Flux	Ф۷	105	112		lm	I _F =120mA
Luminous Efficiency			156		lm/W	I _F =120mA
Chromaticity	Х		0.4599			I _F =120mA
Coordinates	Υ		0.4139			
Colour Temperature	ССТ		2700		К	I _F =120mA
Viewing Angle	2θ _{1/2}		120		deg	I _F =120mA

^{1.} Luminous flux (Φ_V) ±10%, Forward Voltage (V_F) ±0.1V, CRI ±2



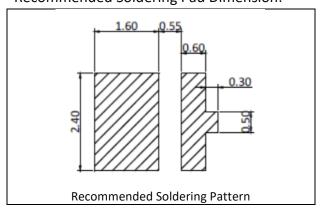
OUTLINE DIMENSION:

Package Dimension:



- 1. All dimensions are in millimetre (mm).
- 2. Tolerance ±0.2mm, unless otherwise noted.

Recommended Soldering Pad Dimension:



- 1. Dimensions are in millimetre (mm).
- 2. Tolerance ±0.1mm with angle tolerance ±0.5°.



BINNING GROUPS:

Forward Voltage Classifications (I_F = 120mA):

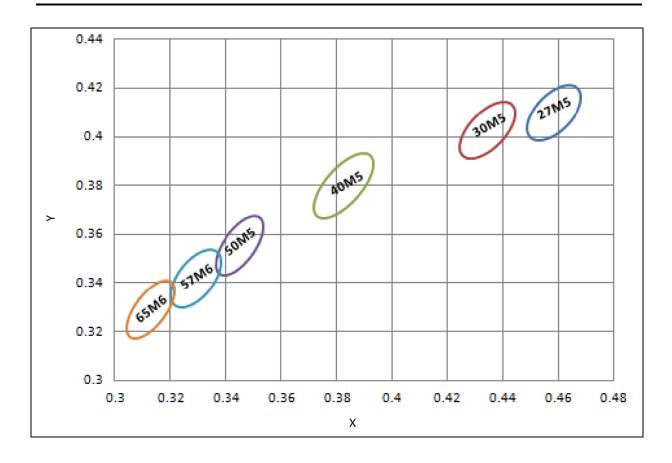
Code	Min.	Max.	Unit
A4	5.8	6.0	
B4	6.0	6.2	V
C4	6.2	6.3	V
D4	6.3	6.6	

Luminous Flux Classifications (I_F = 120mA):

Code	Min.	Max.	Unit
5F	105	110	
5G	110	115	
5H	115	120	lm
5J	120	125	
5K	125	130	



CIE CHROMATICITY DIAGRAM:



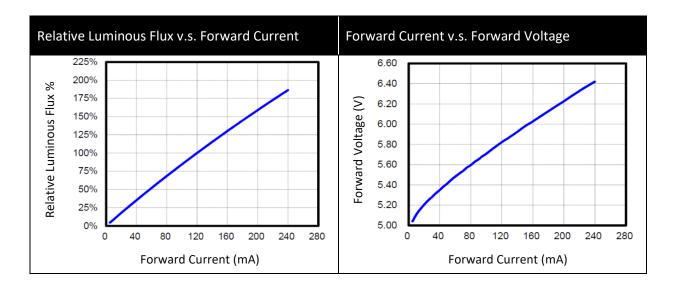
Chromaticity Coordinates Classifications (I_F = 120mA):

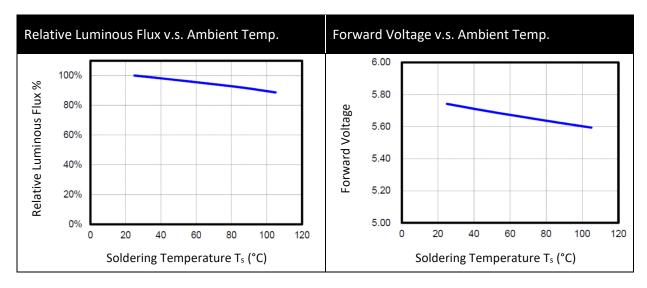
Ra80: *B	Cada	Centre		Radius		Angle
3 *BJ *BK	Code	Х	Υ	а	b	Φ
*BE *BF 6	8B-3STEP	0.4599	0.4139	0.008100	0.004200	53.42
1 *8M *6L 7	8B-5STEP			0.013500	0.007000	

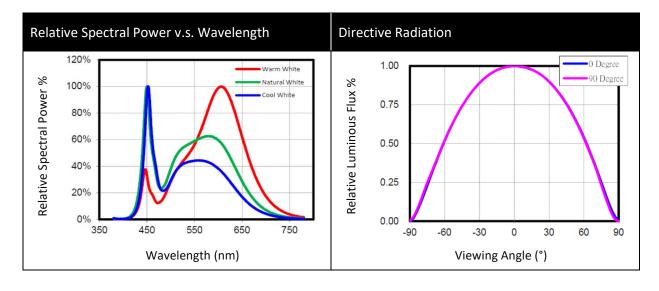
	1	1	2	2	3	3	2	4
	Х	Υ	Х	Y	Х	Υ	Х	Υ
1	0.4387	0.3928	0.4576	0.4295	0.4827	0.4354	0.4607	0.3979



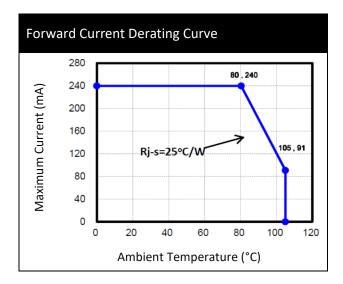
ELECTRO-OPTICAL CHARACTERISTICS:







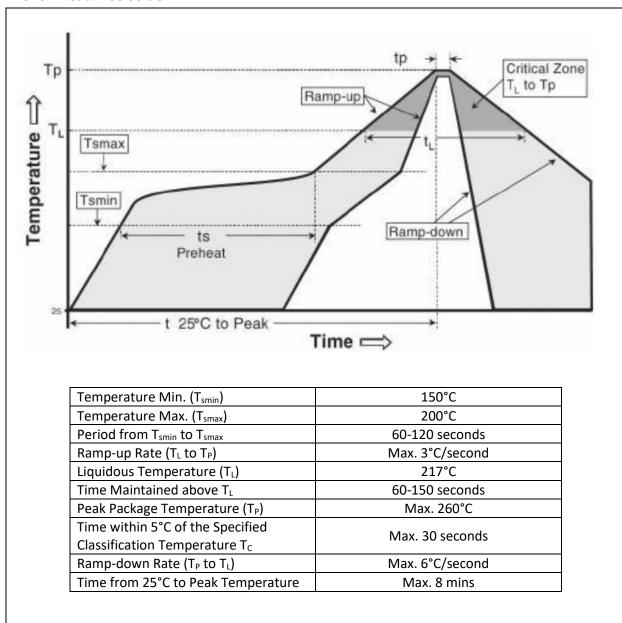






RECOMMENDED SOLDERING PROFILE:

Reflow Lead-free Solder:



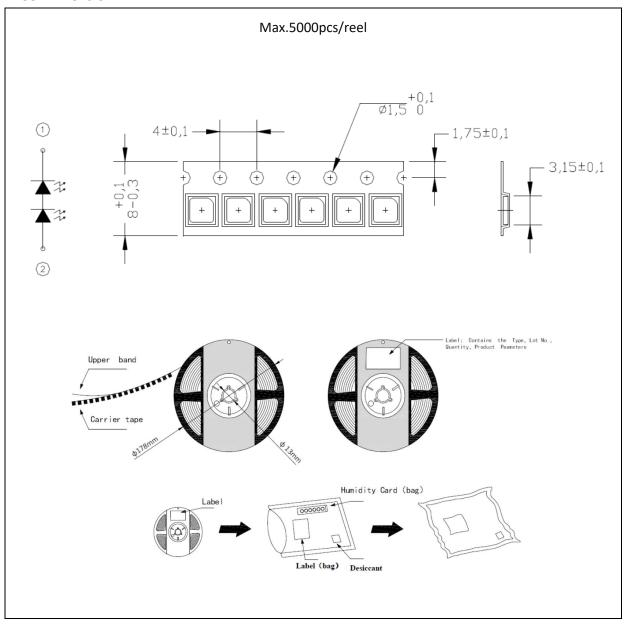
Note:

- 1. Maximum reflow soldering: 2 times.
- 2. Before, during, and after soldering, should not apply stress on the components and PCB board.
- 3. Recommended soldering temperature: 230°C. The maximum soldering temperature should be limited to 260°C for max. 10seconds.



PACKING SPECIFICATION:

Reel Dimension:





PRECAUTIONS OF USE:

Storage:

It is recommended to store the products in the following conditions:

- Humidity: 60% R.H. Max.
- Temperature: 5°C~30°C (41°F ~86°F).

Shelf life in sealed bag: 12 months at 5°C~30°C and <60% R.H.

Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp-proof box with descanting agent <10% R.H. and apply baking before use.

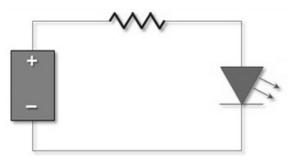
Baking:

It is recommended to bake the LED before soldering if the pack has been unsealed for longer than 24hrs. The suggested baking conditions are as followings:

• 60±3°C x 24hrs and <5%RH, taped / reel package.

It's normal to see slight color fading of carrier (light yellow) after baking in process.

Testing Circuit:



Must apply resistor(s) for protection (over current proof).

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED carrier / package. Avoid putting any stress force directly on to the LED lens.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrosatic glove is recommended when handing the LED all time. All devices, equipment, machinery, work tables, and storage racks must be properly grounded.

In the events of manual working in process, make sure the devices are well protected from ESD at any time.



REVISION RECORD:

Version	Date	Summary of Revision
A1.0	13/07/2022	Datasheet set-up.